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October 2001 Revised March 2004

NC7SP57 • NC7SP58 TinyLogic® ULP Universal Configurable 2-Input Logic Gates

General Description

The NC7SP57 and the NC7SP58 are Universal Configurable 2-Input Logic Gates from Fairchild's Ultra Low Power (ULP) Series of TinyLogic®. Ideal for applications where battery life is critical, this product is designed for ultra low power consumption within the V_{CC} operating range of 0.9V to 3.6V. Each device is capable of being configured for 1 of 5 unique 2-input logic functions. Any possible 2-input combinatorial logic function can be implemented as shown in the Function Selection Table. Device functionality is selected by how the device is wired at the board level. Figure 1 through Figure 10 illustrate how to connect the NC7SP57 and NC7SP58 respectively for the desired logic function. All inputs have been implemented with hysteresis.

The internal circuit is composed of a minimum of inverter stages including the output buffer, to enable ultra low dynamic power.

The NC7SP57 and NC7SP58, for lower drive requirements, are uniquely designed for optimized power and speed, and are fabricated with an advanced CMOS technology to achieve best in class operation while maintaining extremely low CMOS power dissipation.

Features

- 0.9V to 3.6V V_{CC} supply operation
- 3.6V overvoltage tolerant I/O's at V_{CC} from 0.9V to 3.6V
- t_{PD}

5 ns typ for 3.0V to 3.6V V_{CC} 6 ns typ for 2.3V to 2.7V V_{CC} 8 ns typ for 1.65V to 1.95V V_{CC} 10 ns typ for 1.40V to 1.60V V_{CC} 14 ns typ for 1.10V to 1.30V V_{CC} 40 ns typ for 0.90V V_{CC}

- Power-Off high impedance inputs and outputs
- \blacksquare Static Drive (I_OH/I_OL)

 ± 2.6 mA @ 3.00V V_{CC} ± 2.1 mA @ 2.30V V_{CC}

±1.5 mA @ 1.65V V_{CC}

±1.0 mA @ 1.40V V_{CC}

 ± 0.5 mA @ 1.10V $\rm V_{CC}$

 $\pm 20~\mu A~$ @ 0.9V V_{CC}

- Uses patented Quiet Series[™] noise/EMI reduction circuitry
- Ultra small MicroPak™ leadfree package
- Ultra low dynamic power

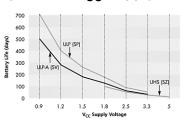
Ordering Code:

Order Number	Package	Product Code	Package Description	Supplied As	
Order Number	Number	Top Mark	Fackage Description	Supplied As	
NC7SP57P6X	MAA06A	P57	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel	
NC7SP57L6X	MAC06A	K9	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel	
NC7SP58P6X	MAA06A	P58	6-Lead SC70, EIAJ SC88, 1.25mm Wide	3k Units on Tape and Reel	
NC7SP58L6X	MAC06A	L3	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel	

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Quiet Series™ and MicroPak™ are trademarks of Fairchild Semiconductor Corporation.

Battery Life vs. V_{CC} Supply Voltage

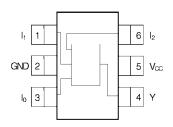


TinyLogic ULP and ULP-A with up to 50% less power consumption can extend your battery life significantly.

Battery Life = (Vb_{attery}* s)_{theres}* (Ve_{person})/24hrs/day Where, $P_{device} = (I_{Cc} * V_{CC}) + (C_{PD} + C_L) * V_{Cc} ^2 * f$ Assumes ideal 3.6V Lithium Ion battery with current rating of 900mAH and derated 90% and device frequency at 10MHz, with $C_L = 15 \, pF$ load

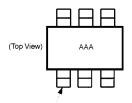
Connection Diagrams

Pin Assignments for SC70



(Top View) NC7SP57 and NC7SP58

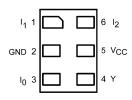
Pin One Orientation Diagram



 $AAA = Product\ Code\ Top\ Mark\ -\ see\ ordering\ code$

Note: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



(Top Thru View)

Pin Descriptions

Pin Name	Description		
l ₀ , l ₁ , l ₂	Data Input		
Y	Output		

Function Table

	Input		NC7SP57	NC7SP58		
l ₂	I ₁	I ₀	$\mathbf{Y} = (\mathbf{I}_0) \bullet (\mathbf{I}_2) + (\mathbf{I}_1) \bullet (\mathbf{I}_2)$	$Y=(I_0){\scriptstyle \bullet}(I_2){\scriptstyle +}(I_1){\scriptstyle \bullet}(I_2)$		
L	L	L	Н	L		
L	L	Н	L	Н		
L	Н	L	Н	L		
L	Н	Н	L	Н		
Н	L	L	L	Н		
Н	L	Н	L	Н		
Н	Н	L	Н	L		
Н	Н	Н	Н	L		

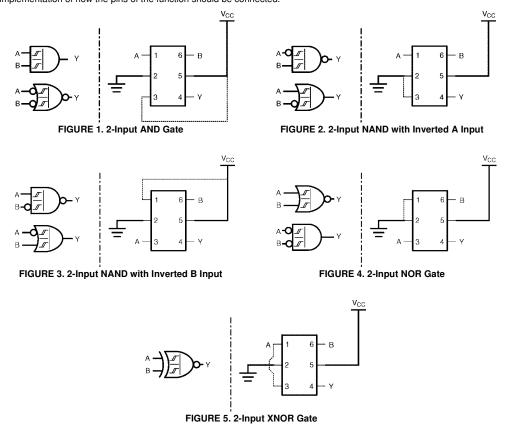
H = HIGH Logic Level L = LOW Logic Level

Function Selection Table

2-Input Logic Function	Device	Connection
2-input Logic Function	Selection	Configuration
2-Input AND	NC7SP57	Figure 1
2-Input AND with inverted input	NC7SP58	Figures 7, 8
2-Input AND with both inputs inverted	NC7SP57	Figure 4
2-Input NAND	NC7SP58	Figure 6
2-Input NAND with inverted input	NC7SP57	Figures 2, 3
2-Input NAND with both inputs inverted	NC7SP58	Figure 9
2-Input OR	NC7SP58	Figure 9
2-Input OR with inverted input	NC7SP57	Figures 2, 3
2-Input OR with both inputs inverted	NC7SP58	Figure 6
2-Input NOR	NC7SP57	Figure 4
2-Input NOR with inverted input	NC7SP58	Figures 7, 8
2-Input NOR with both inputs inverted	NC7SP57	Figure 1
2-Input XOR	NC7SP58	Figure 10
2-Input XNOR	NC7SP57	Figure 5

Logic Configurations NC7SP57

Figure 1 through Figure 5 show the logical functions that can be implemented using the NC7SP57. The diagrams show the DeMorgan's equivalent logic duals for a given 2-input function. Next to the logical implementation is the board level physical implementation of how the pins of the function should be connected.



Logic Configurations NC7SP58

Figure 6 through Figure 10 show the logical functions that can be implemented using the NC7SP58. The diagrams show the DeMorgan's equivalent logic duals for a given 2-input function. Next to the logical implementation is the board level physical implementation of how the pins of the function should be connected.

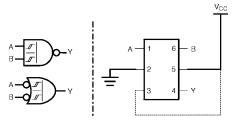
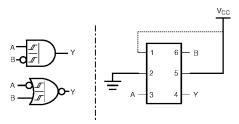


FIGURE 6. 2-Input NAND Gate

FIGURE 7. 2-Input AND with Inverted A Input



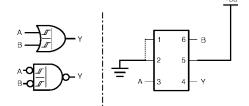


FIGURE 8. 2-Input AND with Inverted B Input

FIGURE 9. 2-Input OR Gate

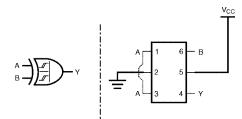


FIGURE 10. 2-Input XOR Gate

Absolute Maximum Ratings(Note 1)

 $\begin{array}{lll} \mbox{Supply Voltage (V$_{CC}$)} & -0.5 \mbox{V to } +4.6 \mbox{V} \\ \mbox{DC Input Voltage (V$_{IN}$)} & -0.5 \mbox{V to } +4.6 \mbox{V} \\ \end{array}$

DC Output Voltage (V_{OUT})

$$\label{eq:local_problem} \begin{split} & \text{HIGH or LOW State (Note 2)} & -0.5\text{V to V}_{\text{CC}} + 0.5\text{V} \\ & \text{V}_{\text{CC}} = 0\text{V} & -0.5\text{V to 4.6V} \\ & \text{DC Input Diode Current (I}_{\text{IK}}) \text{ V}_{\text{IN}} < 0\text{V} & \pm 50 \text{ mA} \end{split}$$

DC Output Diode Current (I_{OK})

DC V_{CC} or Ground Current per

Supply Pin (I $_{CC}$ or Ground) \pm 50 mA Storage Temperature Range (T $_{STG}$) -65° C to +150 $^{\circ}$ C

Recommended Operating Conditions (Note 3)

Supply Voltage 0.9V to 3.6VInput Voltage (V_{IN}) 0V to 3.6V

Output Voltage (V_{OUT})

HIGH or LOW State $$\rm OV\ to\ V_{CC}$$ $V_{CC}=\rm OV$ $\rm OV\ to\ 3.6V$

Output Current in I_{OH}/I_{OL}

 $\begin{array}{lll} V_{CC} = 3.0 \text{V to } 3.6 \text{V} & \pm 2.6 \text{ mA} \\ V_{CC} = 2.3 \text{V to } 2.7 \text{V} & \pm 2.1 \text{ mA} \\ V_{CC} = 1.65 \text{V to } 1.95 \text{V} & \pm 1.5 \text{ mA} \\ V_{CC} = 1.40 \text{V to } 1.60 \text{V} & \pm 1 \text{ mA} \\ V_{CC} = 1.10 \text{V to } 1.30 \text{V} & \pm 0.5 \text{ mA} \\ V_{CC} = 0.9 \text{V} & \pm 20 \text{ } \mu \text{A} \end{array}$

 $V_{CC} = 0.9V \\$ Free Air Operating Temperature (T_A) $-40^{\circ}C \text{ to } +85^{\circ}C$

Minimum Input Edge Rate $(\Delta t/\Delta V)$

 $V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$ 10 ns/V

Note 1: Absolute Maximum Ratings: are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: IO Absolute Maximum Rating must be observed.

Note 3: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	v _{cc}	T _A = -	+25°C	T _A = -40°	C to +85°C	Units	Conditions	
Symbol	Parameter	(V)	Min	Max	Min	Max	Units	Conditions	
V _P	Positive Threshold Voltage	0.90	0.3	0.6	0.3	0.6			
		1.10	0.4	1.0	0.4	1.0			
		1.40	0.5	1.2	0.5	1.2	v		
		1.65	0.7	1.5	0.7	1.5	v		
		2.30	1.0	1.9	1.0	1.9			
			3.0	1.5	2.6	1.5	2.6		
V _N	Negative Threshold Voltage	0.90	0.10	0.6	0.10	0.6			
		1.10	0.15	0.7	0.15	0.7			
		1.40	0.20	8.0	0.20	8.0	v		
		1.65	0.25	0.9	0.25	0.9	v		
		2.30	0.4	1.15	0.4	1.15			
		3.0	0.6	1.5	0.6	1.5			
V _H	Hysteresis Voltage	0.90	0.07	0.5	0.07	0.5			
		1.10	0.08	0.6	0.08	0.6			
		1.40	0.09	8.0	0.09	8.0	v		
		1.65	0.10	1.0	0.10	1.0	v l		
		2.30	0.25	1.1	0.25	1.1			
		3.0	0.60	1.8	0.60	1.8			

DC Electrical Characteristics (Continued)

Symbol	Parameter	V _{CC}	T _A = +	-25°C	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
Syllibol	Farameter	(V)	Min	Max	Min	Max	Offics	Conditions	
V _{OH}	HIGH Level	0.90	V _{CC} - 0.1		V _{CC} - 0.1				
	Output Voltage	$1.10 \le V_{CC} \le 1.30$	$V_{CC} - 0.1$		$V_{CC} - 0.1$				
		$1.40 \le V_{CC} \le 1.60$	$V_{CC} - 0.1$		$V_{CC} - 0.1$			I _{OH} = -20 μA	
		$1.65 \le V_{CC} \le 1.95$	$V_{CC} - 0.1$		$V_{CC} - 0.1$			ΙΟΗ – –20 μΑ	
		$2.30 \leq V_{CC} \leq 2.70$	$V_{CC} - 0.1$		$V_{CC} - 0.1$				
		$3.00 \leq V_{CC} \leq 3.60$	$V_{CC} - 0.1$		$V_{CC} - 0.1$		V		
		$1.10 \le V_{CC} \le 1.30$	0.75 x V _{CC}		0.70 x V _{CC}			$I_{OH} = -0.5 \text{ mA}$	
		$1.40 \le V_{CC} \le 1.60$	1.07		0.99			I _{OH} = -1 mA	
		$1.65 \le V_{CC} \le 1.95$	1.24		1.22			$I_{OH} = -1.5 \text{ mA}$	
		$2.30 \leq V_{CC} \leq 2.70$	1.95		1.87			I _{OH} = -2.1 mA	
		$3.00 \leq V_{CC} \leq 3.60$	2.61		2.55			$I_{OH} = -2.6 \text{ mA}$	
V _{OL}	LOW Level	0.90		0.1		0.1			
	Output Voltage	$1.10 \le V_{CC} \le 1.30$		0.1		0.1			
		$1.40 \leq V_{CC} \leq 1.60$		0.1		0.1		$I_{OL} = 20 \mu A$	
		$1.65 \leq V_{CC} \leq 1.95$		0.1		0.1			
		$2.30 \leq V_{CC} \leq 2.70$		0.1		0.1			
		$3.00 \leq V_{CC} \leq 3.60$		0.1		0.1	V		
		$1.10 \le V_{CC} \le 1.30$		0.30 x V _{CC}		0.30 x V _{CC}		$I_{OL} = 0.5 \text{ mA}$	
		$1.40 \le V_{CC} \le 1.60$		0.31		0.37		I _{OL} = 1 mA	
		$1.65 \le V_{CC} \le 1.95$		0.31		0.35		I _{OL} = 1.5 mA	
		$2.30 \leq V_{CC} \leq 2.70$		0.31		0.33		I _{OL} = 2.1 mA	
		$3.00 \le V_{CC} \le 3.60$		0.31		0.33		I _{OL} = 2.6 mA	
I _{IN}	Input Leakage Current	0.90 to 3.60		±0.1		±0.5	μΑ	$0 \le V_1 \le 3.6V$	
I _{OFF}	Power Off Leakage Current	0		0.5		0.5	μΑ	$0 \le (V_I, V_O) \le 3.6V$	
I _{CC}	Quiescent Supply Current	0.90 to 3.60		0.5		0.9	μΑ	V _I = V _{CC} or GND	

AC Electrical Characteristics

Symbol	Parameter	v _{cc}	T _A = +25°C		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	Figure	
Symbol	Farameter	(V)	Min	Тур	Max	Min	Max	Units	Conditions	Number
t _{PHL} ,	Propagation Delay	0.90		40						
t_{PLH}		$1.10 \leq V_{CC} \leq 1.30$	5.5	14	28.0	5.0	51.0			
		$1.40 \leq V_{CC} \leq 1.60$	4.5	10	17.0	4.0	21.0	ns	C _L = 10 pF	Figures
		$1.65 \leq V_{CC} \leq 1.95$	3.5	8	14.0	3.0	17.0	115	$R_L = 1 M\Omega$	11, 12
		$2.30 \leq V_{CC} \leq 2.70$	2.5	6	10.0	2.0	13.0			
		$3.00 \leq V_{CC} \leq 3.60$	1.5	5	8.0	1.0	12.0			
t _{PHL} ,	Propagation Delay	0.90		41						
t_{PLH}		$1.10 \leq V_{CC} \leq 1.30$	6.5	15	29.0	6.0	52.0			
		$1.40 \leq V_{CC} \leq 1.60$	5.0	10	18.0	4.5	22.0	ns	C _L = 15 pF	Figures
		$1.65 \leq V_{CC} \leq 1.95$	4.0	8	15.0	3.5	18.0	115	$R_L = 1 M\Omega$	11, 12
		$2.30 \leq V_{CC} \leq 2.70$	3.0	6	11.0	2.5	14.0			
		$3.00 \leq V_{CC} \leq 3.60$	2.0	5	9.0	1.5	12.0			
t _{PHL} ,	Propagation Delay	0.90		46						
t_{PLH}		$1.10 \leq V_{CC} \leq 1.30$	7.0	17	32.0	6.5	55.0			
		$1.40 \leq V_{CC} \leq 1.60$	5.5	11	20.0	5.0	24.0	ns	C _L = 30 pF	Figures
		$1.65 \leq V_{CC} \leq 1.95$	4.5	9	17.0	4.0	20.0	115	$R_L = 1 M\Omega$	11, 12
		$2.30 \leq V_{CC} \leq 2.70$	3.5	7	12.0	3.0	15.0			
		$3.00 \leq V_{CC} \leq 3.60$	2.5	6	11.0	2.0	14.0			
C _{IN}	Input Capacitance	0		2.0				pF		
C _{OUT}	Output Capacitance	0		4.0				pF		
C _{PD}	Power Dissipation Capacitance	0.9 to 3.60		8				pF	$V_I = 0V \text{ or } V_{CC},$ f = 10 MHz	

AC Loading and Waveforms

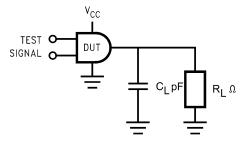


FIGURE 11. AC Test Circuit

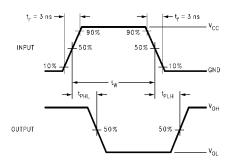


FIGURE 12. AC Waveforms

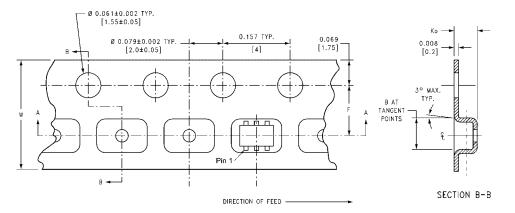
Symbol	V _{CC}								
Symbol	$3.3V \pm 0.3V$	$\textbf{2.5V} \pm \textbf{0.2V}$	$\textbf{1.8V} \pm \textbf{0.15V}$	1.5V ± 0.10V	$1.2V \pm 0.10V$	0.9V			
V _{mi}	1.5V	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2			
V _{mo}	1.5V	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2			

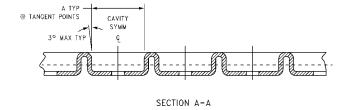
Tape and Reel Specification

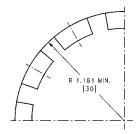
TAPE FORMAT for SC70

Package	Tape	Number	Cavity	Cover Tape
Designator	Section	Cavities	Status	Status
	Leader (Start End)	125 (typ)	Empty	Sealed
P6X	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)

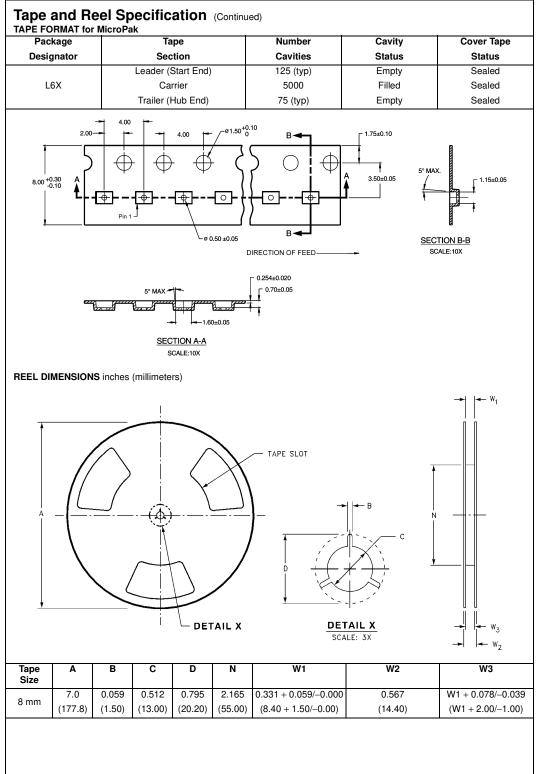






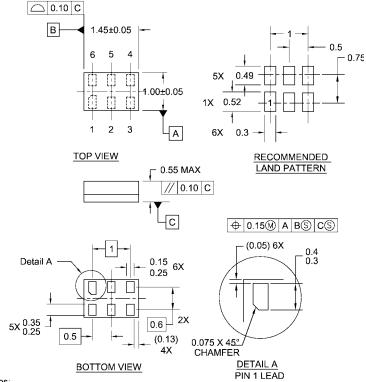
BEND RADIUS NOT TO SCALE

Package	Tape Size	DIM A	DIM B	DIMF	DIM K _o	DIM P1	DIM W
SC70-6	8 mm	0.093	0.096	0.138 ± 0.004	0.053 ± 0.004	0.157	0.315 ± 0.004
	o IIIIII	(2.35)	(2.45)	(3.5 ± 0.10)	(1.35 ± 0.10)	(4)	(8 ± 0.1)



Physical Dimensions inches (millimeters) unless otherwise noted 0.65 1.9 .B. 1.25±0.10 2.10±0.10 -0.20 ^{+0.10} -0.05 LAND PATTERN RECOMMENDATION ♦ max 0.1 **®** ____ max 0.1 R0.14 GAGE PLANE 0.20 0.45 0.10 DETAIL A NOTES: A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88. B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH. C. DIMENSIONS ARE IN MILLIMETERS. MAA06ARevC 6-Lead SC70, EIAJ SC88, 1.25mm Wide Package Number MAA06A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



- Notes:
- 1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide Package Number MAC06A

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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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